

# **SWITCHMODE** <sup>™</sup> **Series NPN Silicon Power Transistor**

... designed for high speed, high current, high power applications.

• High DC current gain:

$$h_{FE}$$
 min = 20 at  $I_C$  = 25 A = 10 at  $I_C$  = 50 A

• Low V<sub>CE(sat)</sub>:

$$\begin{split} &V_{CE(sat)} \; max. = 0.6 \; V \; at \; I_C = 25 \; A \\ &= 0.9 \; V \; at \; I_C = 50 \; A \end{split}$$

• Very fast switching times:

$$T_F = 0.25 \ \mu s \ at \ I_C = 50 \ A$$

## **MAXIMUM RATINGS**

Rating	Symbol	BUV20	BUV60	Unit
Collector–Emititer Voltage	V <sub>CEO(sus)</sub>	125		Vdc
Collector–Base Voltage	V <sub>CBO</sub>	160	260	Vdc
Emitter–Base Voltage	$V_{EBO}$	7		Vdc
Collector–Emitter Voltage (V <sub>BE</sub> = -1.5 V)	V <sub>CEX</sub>	160	260	Vdc
Collector–Emitter voltage ( $R_{BE} = 100 \Omega$ )	V <sub>CER</sub>	150	260	Vdc
Collector–Current — Continuous — Peak (PW ≤ 10 ms)	I <sub>C</sub> I <sub>CM</sub>	50 60		Adc Apk
Base-Current continuous	I <sub>B</sub>	10		Adc
Total Power Dissipation @ T <sub>C</sub> = 25°C	P <sub>D</sub>	250		Watts
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to 200		°C

## THERMAL CHARACTERISTICS

Characteristic	Symbol	BUV20	BUV60	Unit
Thermal Resistance, Junction to Case	$\theta_{\text{JC}}$	0.7		°C/W

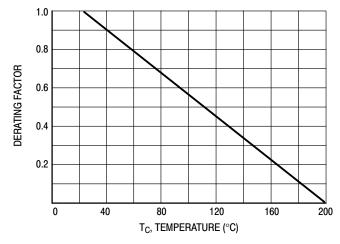


Figure 1. Power Derating

# **BUV20 BUV60**

50 AMPERES
NPN SILICON
POWER
METAL TRANSISTOR
125 VOLTS
250 WATTS



CASE 197A-05 TO-204AE (TO-3)

# **BUV20 BUV60**

# **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS <sup>1</sup>			•	•	•
Collector–Emitter Sustaining Vol (I <sub>C</sub> = 200 mA, I <sub>B</sub> = 0, L = 25 m	S .	V <sub>CEO(sus)</sub>	125		Vdc
Collector Cutoff Current at Reve $(V_{CE} = 140 \text{ V}, V_{BE} = -1.5 \text{ V})$ $(V_{CE} = 140 \text{ V}, V_{BE} = -1.5 \text{ V}, T_{CE} = 260 \text{ V}, V_{BE} = -1.5 \text{ V})$	BUV20	I <sub>CEX</sub>		3.0 12	mAdo
Collector–Emitter Cutoff Current (V <sub>CE</sub> = 100 V)	BUV20	I <sub>CEO</sub>		3.0	mAdo
Emitter–Base Reverse Voltage (I <sub>E</sub> = 50 mA)	BUV20, BUV60	V <sub>EBO</sub>	7		V
Emitter–Cutoff Current (V <sub>EB</sub> = 5 V) BUV20		I <sub>EBO</sub>		1.0	mAdo
SECOND BREAKDOWN			<u>'</u>	1	•
Second Breakdown Collector Current with base forward biased (V <sub>CE</sub> = 20 V, t = 1 s) (V <sub>CE</sub> = 40 V, t = 1 s)		I <sub>S/b</sub>	12 1.5		Adc
ON CHARACTERISTICS <sup>1</sup>			<u>I</u>	I	
DC Current Gain ( $I_C = 25 \text{ A}, V_{CE} = 2 \text{ V}$ ) ( $I_C = 50 \text{ A}, V_{CE} = 4 \text{ V}$ )	BUV20 BUV20	h <sub>FE</sub>	20 10	60 -	
Collector–Emitter Saturation Vol ( $I_C = 25 \text{ A}, I_B = 2.5 \text{ A}$ ) ( $I_C = 50 \text{ A}, I_B = 5 \text{ A}$ )	tage BUV20 BUV20	V <sub>CE(sat)</sub>		0.6 1.2	Vdc
Base–Emitter Saturation Voltage (I <sub>C</sub> = 50 A, I <sub>B</sub> = 5 A)0		V <sub>BE(sat)</sub>		2.0	Vdc
	tage BUV60 BUV60 BUV60	V <sub>CE(sat)</sub>		0.9 0.9 1.2	Vdc
Base–Emitter Saturation Voltage $(I_C = 50 \text{ A}, I_B = 5 \text{ A})$ $(I_C = 60 \text{ A}, I_B = 7.5 \text{ A})$		V <sub>BE(sat)</sub>		1.6 1.8	Vdc
DYNAMIC CHARACTERISTICS	-				•
Current Gain — Bandwidth Prod ( $V_{CE} = 15 \text{ V}, I_{C} = 2 \text{ A}, f = 4 \text{ MHz}$		f <sub>T</sub>	8.0		MHz
SWITCHING CHARACTERISTIC	S (Resistive Load)				
Turn-on Time		t <sub>on</sub>		1.5	μs
Storage Time	$(I_C = 50 \text{ A}, I_{B1} = I_{B2} = 5 \text{ A}, V_{CC} = 30 \text{ V}, R_C = 0.6 \Omega)$	ts		1.2	
Fall Time	00 / 10 /	t <sub>f</sub>		0.25	

<sup>&</sup>lt;sup>1</sup> Pulse Test: Pulse Width  $\leq 300 \,\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

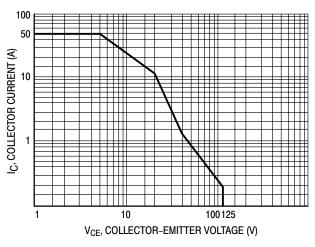


Figure 2. Active Region Safe Operating Area

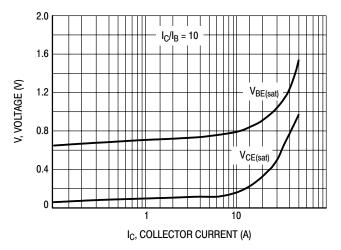


Figure 3. "On" Voltages

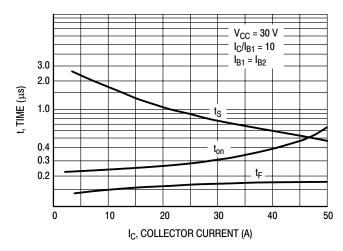


Figure 5. Resistive Switching Performance

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate  $I_C - V_{CE}$  limits of the transistor that must be observed for reliable operation i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 2 is based on  $T_C = 25^{\circ}C$ .  $T_{J(pk)}$  is variable depending on power level. Second breakdown limitations do not derate the same as thermal limitations.

At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

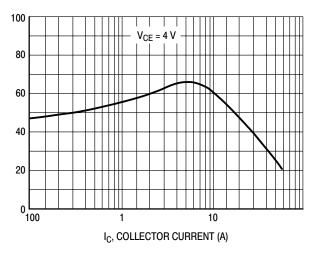
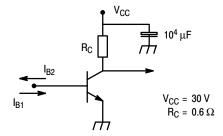


Figure 4. DC Current Gain



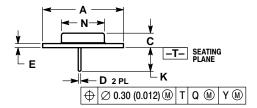
R<sub>C</sub> — Non inductive resistance

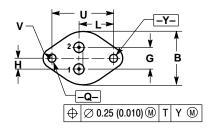
Figure 6. Switching Times Test Circuit

### **BUV20 BUV60**

#### PACKAGE DIMENSIONS

# TO-204AE (TO-3) CASE 197A-05 ISSUE J





#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
   V14 FM 1082
- Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH

	OONTHOLLING DIMENSION. INON.				
	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	1.530	1.530 REF		38.86 REF	
В	0.990	1.050	25.15	26.67	
С	0.250	0.335	6.35	8.51	
D	0.057	0.063	1.45	1.60	
E	0.060	0.070	1.53	1.77	
G	0.430 BSC		10.92 BSC		
Н	0.215	BSC	5.46	BSC	
K	0.440	0.480	11.18	12.19	
L	0.665 BSC		16.89 BSC		
N	0.760	0.830	19.31	21.08	
Q	0.151	0.165	3.84	4.19	
U	1.187 BSC		30.15 BSC		
٧	0.131	0.188	3.33	4.77	

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